

A

Pin heatsinks

B

C

D

E

F

G

H

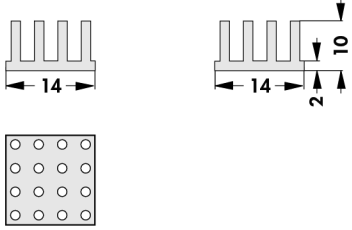
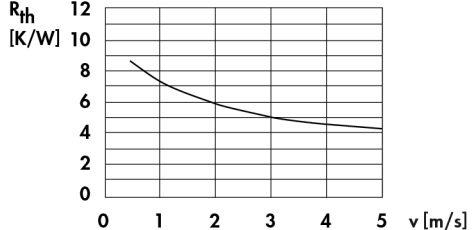
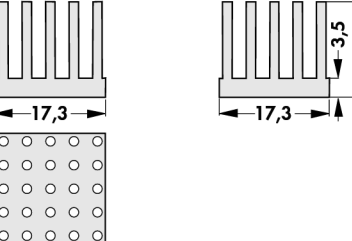
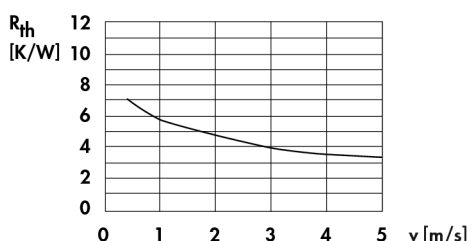
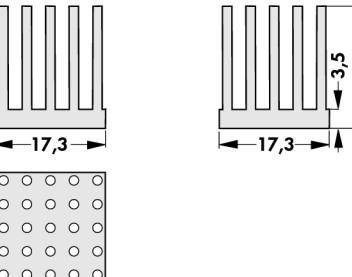
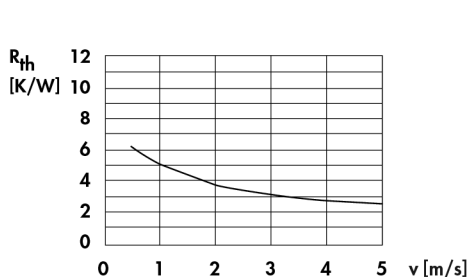
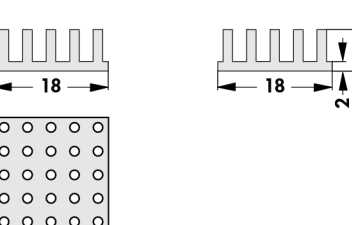
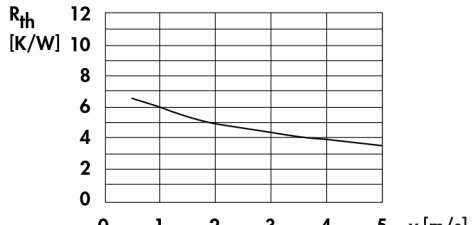
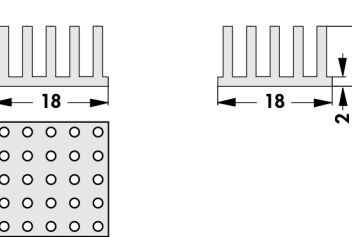
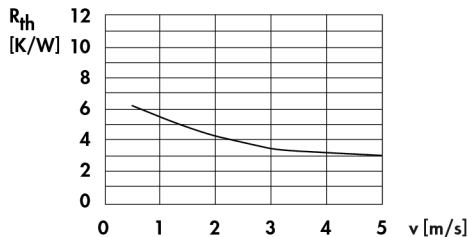
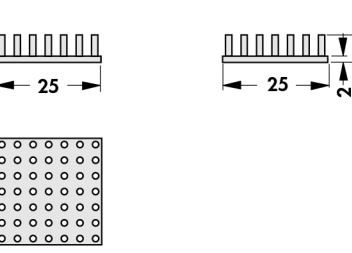
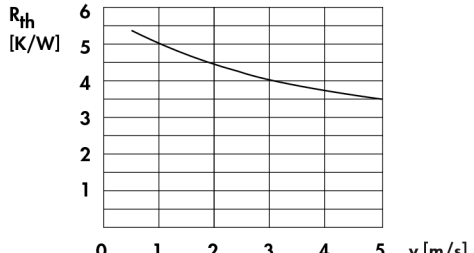
I

K

L

M

N

art. no. ICK S 14 x 14 x 10 WLF ... 14 x 14 weight: 1.9 g		
art. no. ICK S 17 x 17 x 15 WLF ... 17 x 17 weight: 4.7 g		
art. no. ICK S 17 x 17 x 20 WLF ... 17 x 17 weight: 5.6 g		
art. no. ICK S 18 x 18 x 6,5 WLF ... 18 x 18 weight: 2.5 g		
art. no. ICK S 18 x 18 x 10 WLF ... 18 x 18 weight: 3.1 g		
art. no. ICK S 25 x 25 x 6,5 WLF ... 25 x 25 weight: 4 g		

B 17

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